**Product data sheet** 

### 1. General description

The NX5DV713 is a dual supply 1-to-2 VGA switch. It integrates high-bandwidth SPDT switches with level-translating buffers and level translating switches to provide switching of input RGB, H-sync, V-sync and DDC signals to either of two output channels.

The NX5DV713 is characterized for operation from -40 °C to +85 °C.

### 2. Features and benefits

- RGB switches:
  - Low ON resistance (4 Ω typical)
  - Low ON capacitance (12 pF typical)
  - Low output skew (50 ps)
- Low power consumption (< 2 μA)</p>
- Level translation of sync and DDC signals
- Over-voltage tolerant inputs
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 4 kV
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101D exceeds 1000 V
  - IEC61000-4-2 contact discharge exceeds 4 kV for I/Os
- Specified from –40 °C to +85 °C

## 3. Applications

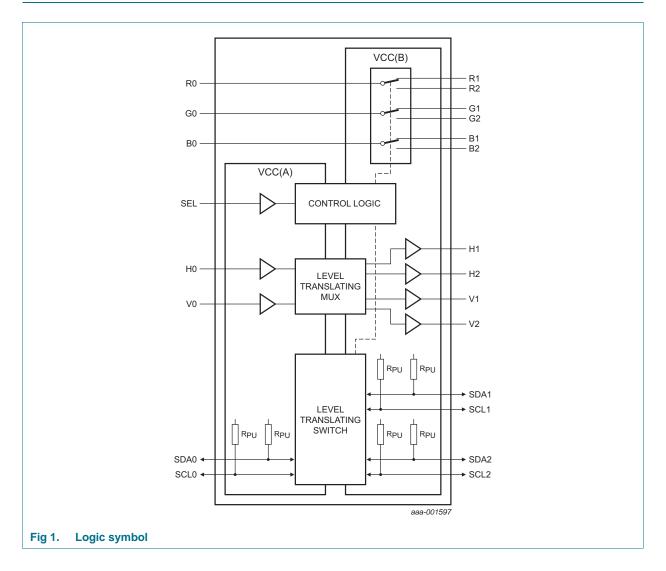
- Notebook Computers
- Docking stations
- Digital projectors
- Computer monitors
- Servers
- Storage



# 4. Ordering information

| Table 1. Ordering information |                   |         |   |           |  |  |  |
|-------------------------------|-------------------|---------|---|-----------|--|--|--|
| Type number                   | Package           |         |   |           |  |  |  |
|                               | Temperature range | Name    | Description   | Version   |  |  |  |
| NX5DV713HF                    | –40 °C to +85 °C  | HWQFN32 | plastic thermal enhanced very very thin quad flat package; no leads; 32 terminals; body $3 \times 6 \times 0.75$ mm | SOT1180-1 |  |  |  |

# 5. Functional diagram



NX5DV713 Product data sheet

# 6. Pinning information

### 6.1 Pinning

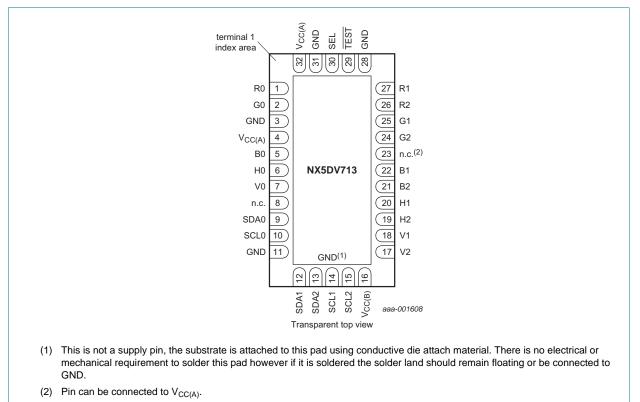


Fig 2. Pin configuration SOT1180-1 (HWQFN32)

### 6.2 Pin description

| Symbol             | Pin                  | Description           |
|--------------------|----------------------|-----------------------|
| R0, G0, B0         | 1, 2, 5              | RGB input or output   |
| GND                | 3, 11, 28, 31        | ground (0 V)          |
| V <sub>CC(A)</sub> | 4, 32                | supply voltage A      |
| H0                 | 6                    | horizontal sync input |
| VO                 | 7                    | vertical sync input   |
| n.c.               | 8, 23 <sup>[2]</sup> | not connected         |
| SDA0               | 9                    | SDA0 input or output  |
| SCL0               | 10                   | SCL0 input or output  |
| SDA1, SDA2         | 12, 13               | SDAn input or output  |
| SCL1, SCL2         | 14, 15               | SCLn input or output  |
| V <sub>CC(B)</sub> | 16                   | supply voltage B      |
| V1, V2             | 18, 17               | vertical sync output  |

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| Table 2.            | Pin description continued |                        |                        |  |  |
|---------------------|---------------------------|------------------------|------------------------|--|--|
| Symbol              |                           | Pin                    | Description            |  |  |
| H1, H2              |                           | 20, 19                 | horizontal sync output |  |  |
| R1, G1, B1          | , R2, G2, B2              | 27, 25, 22, 26, 24, 21 | RGB input or output    |  |  |
| TEST <sup>[1]</sup> |                           | 29                     | test pin (active LOW)  |  |  |
| SEL                 |                           | 30                     | select input           |  |  |

[1] Test pin used to enable test mode. For normal usage, this pin must be connected to V<sub>CC(A)</sub>.

[2] Pin can be connected to V<sub>CC(A)</sub>.

# 7. Functional description

The NX5DV713 integrates high-bandwidth SPDT switches, level-translating buffers and level translating SPDT switches to provide a complete solution for 1-to-2 switching of VGA signals. A select input (SEL) is used to determine which output is selected.

### 7.1 RGB switches

The NX5DV713 provides three identical single pole double throw high-bandwidth switches to route standard VGA RGB signals (see <u>Table 3</u>).

| Table 3. | Function table | RGB |
|----------|----------------|-----|
|----------|----------------|-----|

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

| Input | Switch                       |
|-------|------------------------------|
| SEL   |                              |
| L     | R0 to R1; G0 to G1; B0 to B1 |
| Н     | R0 to R2; G0 to G2; B0 to B2 |

### 7.2 H-Sync/V-Sync level translator

The horizontal and vertical synchronization buffers have inputs (H0, V0) referenced to  $V_{CC(A)}$  and outputs (H1, V1 and H2,V2) that are referenced to  $V_{CC(B)}$ . This allows level translation of synchronization signals from as low as 2.0 V up to 5.5 V and supports low-voltage CMOS or TTL-compatible graphics controllers meeting the VESA specification for output drive of  $\pm 8$  mA.

#### Table 4. Function table HV

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

| Input | Switch                       |
|-------|------------------------------|
| SEL   |                              |
| L     | H1 = H0; V1 = V0; H2, V2 = L |
| Н     | H2 = H0; V2 = V0; H1, V1 = L |

### 7.3 Display-Data Channel Multiplexer

The NX5DV713 provides two identical SPDT active-level translating switches to route DDC signals (See <u>Table 5</u>). The switch outputs are limited to a diode drop less than the voltage applied on V<sub>CC(A)</sub>. To provide VESA I<sup>2</sup>C-compatible signals 3.3 V should be applied to V<sub>CC(A)</sub>. If voltage translation is not required V<sub>CC(A)</sub> should be connected to V<sub>CC(B)</sub>. Switch terminals include integrated pull-up resistors; inputs (SDA0, SCL0) are pulled up to V<sub>CC(A)</sub>, outputs (SDA1, SCL1 and SDA2, SCL2) are pulled up to V<sub>CC(B)</sub>.

### Table 5.Function table DDC

H = HIGH voltage level; L = LOW voltage level; X = Don't care.

| Input | Switch                     |
|-------|----------------------------|
| SEL   |                            |
| L     | SDA0 to SDA1, SCL0 to SCL1 |
| Н     | SDA0 to SDA2, SCL0 to SCL2 |

### 8. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

|                    |                         |   |                 |      | ,    |
|--------------------|-------------------------|---|-----------------|------|------|
| Symbol             | Parameter               | Conditions  | Min             | Max  | Unit |
| V <sub>CC(A)</sub> | supply voltage A        |   | -0.5            | +6   | V    |
| V <sub>CC(B)</sub> | supply voltage B        |   | -0.5            | +6   | V    |
| VI                 | input voltage           |   | <u>[1]</u> –0.5 | +6   | V    |
| V <sub>SW</sub>    | switch voltage          |   | <u>[1]</u> –0.5 | +6   | V    |
| I <sub>IK</sub>    | input clamping current  | $V_{l} < -0.5 V$  | -50             | -    | mA   |
| I <sub>SK</sub>    | switch clamping current | $V_{\rm I} < -0.5 \ V$  | -50             | -    | mA   |
| I <sub>OK</sub>    | output clamping current | V <sub>O</sub> < 0 V  | -50             | -    | mA   |
| lo                 | output current          | $V_{O} = 0 V$ to $V_{CC(B)}$  | -               | ±50  | mA   |
| I <sub>CC</sub>    | supply current          | I <sub>CC(A)</sub> or I <sub>CC(B)</sub>  | -               | 100  | mA   |
| I <sub>GND</sub>   | ground current          |   | -100            | -    | mA   |
| I <sub>SW</sub>    | switch current          | $V_{SW}$ > -0.5 V or $V_{SW}$ < 6 V;<br>source or sink current                                      | -               | ±30  | mA   |
|                    |                         | $V_{SW}$ > -0.5 V or $V_{SW}$ < 6 V;<br>pulsed at 1 ms duration, < 10 % duty cycle;<br>peak current | -               | ±90  | mA   |
| T <sub>stg</sub>   | storage temperature     |   | -65             | +150 | °C   |
| P <sub>tot</sub>   | total power dissipation | $T_{amb} = -40 \text{ °C to } +85 \text{ °C}$   | [2] _           | 250  | mW   |

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] For HWQFN32 package: above 137 °C the value of P<sub>tot</sub> derates linearly with 20.5 mW/K.

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Dual supply 1-of-2 VGA switch

#### **Recommended operating conditions** 9.

| Table 7.              | Recommended operating conditi       | ons   |              |     |     |      |
|-----------------------|-------------------------------------|---|--------------|-----|-----|------|
| Symbol                | Parameter                           | Conditions                                    | Min          | Тур | Max | Unit |
| V <sub>CC(A)</sub>    | supply voltage A                    |   | 2            | 3.3 | 5.5 | V    |
| V <sub>CC(B)</sub>    | supply voltage B                    |   | 4.5          | 5.0 | 5.5 | V    |
| T <sub>amb</sub>      | ambient temperature                 | operating in free-air                         | -40          | +25 | +85 | °C   |
| $\Delta t / \Delta V$ | input transition rise and fall rate | $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$ | <u>[1]</u> _ | 20  | -   | ns/V |
|                       |                                     | $V_{CC(A)} = 3 V \text{ to } 3.6 V$           | <u>[1]</u> _ | 10  | -   | ns/V |
|                       |                                     | $V_{CC(A)} = 4.5 \text{ V to } 5.5 \text{ V}$ | <u>[1]</u> _ | 5   | -   | ns/V |

[1] Applies to control signal levels.

# **10. Static characteristics**

#### Table 8. Static characteristics

 $V_{CC(B)} = 4.5$  V to 5.5 V;  $V_{CC(A)} = 2$  V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

| Symbol                | Parameter                               | Conditions   |            | T <sub>amb</sub> =       | –40 °C to            | +85 °C             | Uni         |
|-----------------------|---|--|------------|--------------------------|----------------------|--------------------|-------------|
|                       |   |  |            | Min                      | Typ <mark>[1]</mark> | Max                |             |
| General               |   |  |            |                          |                      |                    |             |
| I <sub>CC(A)</sub>    | supply current A                        | $V_{CC(A)}$ = 3.3 V; for H1, H2, V1, V2:<br>I <sub>O</sub> = 0 A; SCLn, SDAn unconnected                                       |            | -                        | -                    | 2.0                | μΑ          |
| I <sub>CC(B)</sub>    | supply current B                        | $V_{CC(B)} = 5.0 \text{ V}$ ; for H1, H2, V1, V2:<br>I <sub>O</sub> = 0 A; SCLn, SDAn unconnected                              |            | -                        | -                    | 2.0                | μA          |
| HV buffe              | r                                       |  |            |                          |                      |                    |             |
| V <sub>IH</sub>       | HIGH-level input voltage                | $V_{CC(A)} = 3 V \text{ to } 3.6 V$  |            | 2                        | -                    | -                  | V           |
| V <sub>IL</sub>       | LOW-level input voltage                 | $V_{CC(A)} = 3 V \text{ to } 3.6 V$  |            | -                        | -                    | 0.8                | V           |
| V <sub>H</sub>        | hysteresis voltage                      |  |            | -                        | 50                   | -                  | mV          |
| lı                    | input leakage current                   | $V_{CC(B)} = V_{CC(A)} = 5.5 V;$<br>V <sub>I</sub> = GND to V <sub>CC(A)</sub>   |            | -                        | -                    | ±1                 | μA          |
| V <sub>OH</sub>       | HIGH-level output voltage               | I <sub>O</sub> = -8 mA   |            | V <sub>CC(B)</sub> - 0.5 | -                    | -                  | V           |
| V <sub>OL</sub>       | LOW-level output voltage                | I <sub>O</sub> = 8 mA  |            | -                        | -                    | 0.5                | V           |
| I <sub>OFF</sub>      | power-off leakage current               |  |            | -                        | -                    | ±1                 | μA          |
| RGB swi               | tches                                   |  |            |                          |                      |                    |             |
| I <sub>S(OFF)</sub>   | OFF-state leakage<br>current            | $V_{CC(B)} = 5.5 \text{ V}; V_1 = 0.3 \text{ V or } 5.5 \text{ V};$<br>$V_0 = 0 \text{ V to } V_{CC(B)}; \text{ See Figure 3}$ |            | -                        | -                    | ±1                 | μA          |
| I <sub>S(ON)</sub>    | ON-state leakage current                | $V_{CC(B)} = 5.5 \text{ V}; V_I = 0.3 \text{ V or } 5.5 \text{ V};$<br>$V_O = 0 \text{ V to } V_{CC(B)}; \text{ See Figure 4}$ |            | -                        | -                    | ±1                 | μA          |
| R <sub>ON</sub>       | ON resistance                           | $V_I = 0.7 \text{ V}; I_{SW} = -10 \text{ mA}; \text{See } \frac{\text{Figure 5}}{\text{Figure 6}}$                            | <u>[4]</u> | -                        | 4                    | -                  | Ω           |
| ∆R <sub>ON</sub>      | ON resistance mismatch between channels | $V_{I}$ = GND to 0.7 V; $I_{SW}$ = –10 mA  | [2]        | -                        | 0.5                  | -                  | Ω           |
| R <sub>ON(flat)</sub> | ON resistance (flatness)                | $V_{I}$ = GND to 0.7 V; $I_{SW}$ = $-10\mbox{ mA}$   | [3]        | -                        | 0.5                  | -                  | Ω           |
| C <sub>S(OFF)</sub>   | OFF-state capacitance                   |  |            | -                        | 4.5                  | -                  | pF          |
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| -                     |   |  |            | -                        |                      | -                  | -           |

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#### Dual supply 1-of-2 VGA switch

| Symbol              | Parameter                    | Conditions   |     | T <sub>amb</sub> = -  | T <sub>amb</sub> = −40 °C to +85 °C |                | Unit |
|---------------------|------------------------------|--|-----|-----------------------|-------------------------------------|----------------|------|
|                     |                              |  |     | Min                   | Typ <mark>[1]</mark>                | Max            |      |
| C <sub>S(ON)</sub>  | ON-state capacitance         |  |     | -                     | 12                                  | -              | pF   |
| SDAn, S             | CLn                          |  |     |                       |                                     |                |      |
| I <sub>S(OFF)</sub> | OFF-state leakage<br>current | $\label{eq:VCC(B)} \begin{array}{l} V_{CC(B)} = 5.5 \; V; \; V_{CC(A)} = 3.6 \; V; \; SCL0, \\ SDA0, \; SCL1, \; SCL2, \; SDA1, \; SDA2 = \\ V_{CC(A)} \; or \; GND; \; V_{O} = 0 \; V \; to \; V_{CC(B)}; \\ See \; \underline{Figure 3} \end{array}$ | [5] | -                     | -                                   | ±1             | μΑ   |
| R <sub>ON</sub>     | ON resistance                | $V_{CC(A)} = 2 V$ ; $V_I = 0.4 V$ ; $I_{SW} = \pm 2 mA$ ;<br>See <u>Figure 5</u> and <u>Figure 7</u>   |     | -                     | 9                                   | -              | Ω    |
| C <sub>S(ON)</sub>  | ON-state capacitance         |  |     | -                     | 15                                  | -              | pF   |
| R <sub>PU</sub>     | pull-up resistance           |  |     | -                     | 4.7                                 | -              | kΩ   |
| Control I           | Logic (SEL)                  |  |     |                       |                                     |                |      |
| VIH                 | HIGH-level input voltage     | $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$  |     | 1.7                   | -                                   |                | V    |
|                     |                              | $V_{CC(A)} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$  |     | 2.0                   | -                                   |                | V    |
|                     |                              | $V_{CC(A)} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$  |     | 0.7V <sub>CC(A)</sub> | -                                   |                | V    |
| VIL                 | LOW-level input voltage      | $V_{CC(A)} = 2.3 \text{ V to } 2.7 \text{ V}$  |     | -                     | -                                   | 0.7            | V    |
|                     |                              | $V_{CC(A)} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$  |     | -                     | -                                   | 0.8            | V    |
|                     |                              | $V_{CC(A)} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$  |     | -                     | -                                   | $0.3V_{CC(A)}$ | V    |
| V <sub>H</sub>      | hysteresis voltage           |  |     | -                     | 50                                  | -              | mV   |
| l <sub>l</sub>      | input leakage current        | $V_{CC(A)} = 5.5 \text{ V}; \text{ V}_{I} = \text{GND to } V_{CC(A)}$  |     | -                     | -                                   | ±1             | μA   |

#### Table 8. Static characteristics ... continued

 $V_{CC(B)} = 4.5$  V to 5.5 V;  $V_{CC(A)} = 2$  V to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

[1] All typical values are measured at  $V_{CC(B)} = 5 V$ ,  $V_{CC(A)} = 3.3 V$  and  $T_{amb} = 25 °C$  unless otherwise specified.

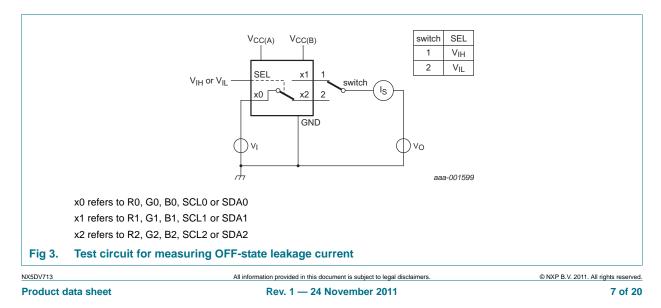
[2] Measured at identical  $V_{CC}$ , temperature and input voltage.

[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

[4] Guarantees the LOW level.

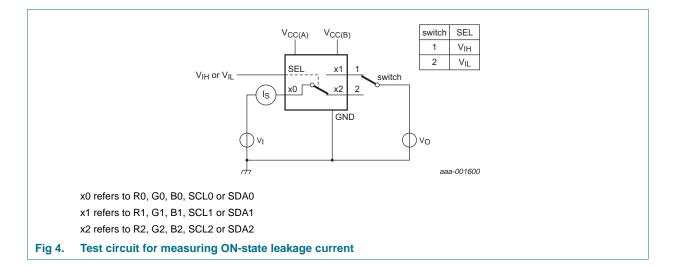
[5] Guarantees the HIGH level.

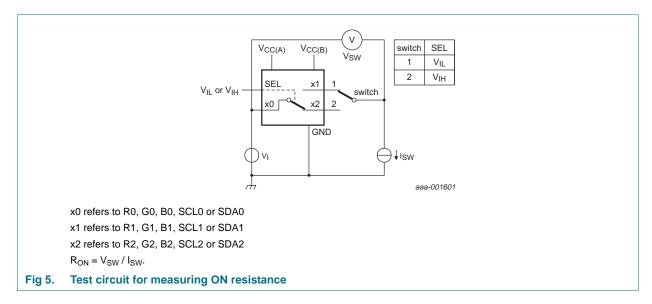
### **10.1 Test circuits and waveforms**





### Dual supply 1-of-2 VGA switch

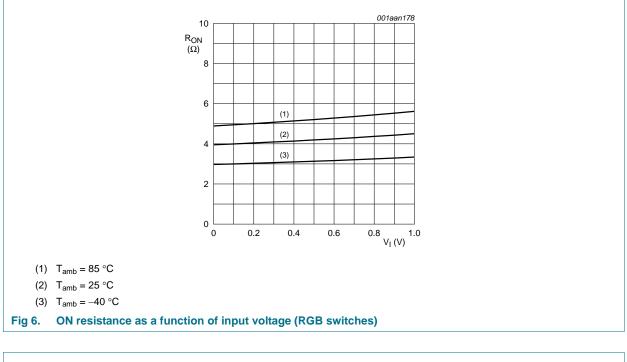


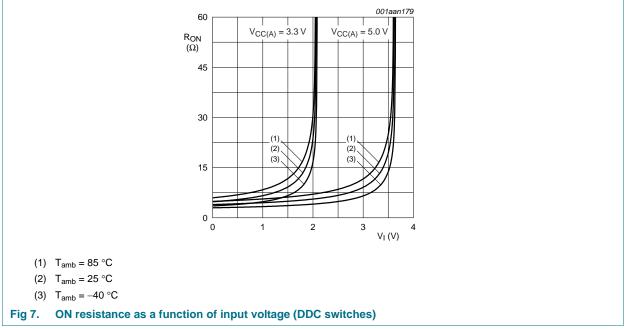


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### Dual supply 1-of-2 VGA switch





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# **11. Dynamic characteristics**

### Table 9. Dynamic characteristics

At recommended operating conditions; Voltages are referenced to GND (ground = 0 V;  $V_{CC(B)} = 4.5$  V to 5.5 V;  $V_{CC(A)} = 2$  V to 5.5 V.

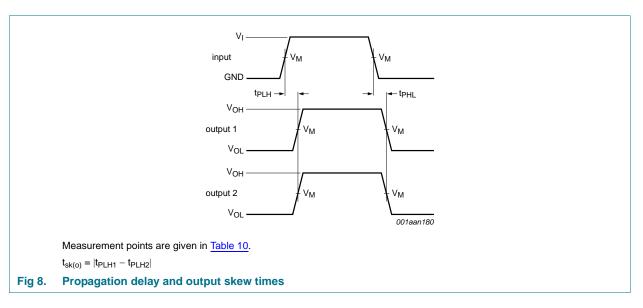
| Symbol             | Parameter                 | Conditions  |            | T <sub>amb</sub> = -40 °C to +85 °C |                      |     | Unit |
|--------------------|---------------------------|---|------------|-------------------------------------|----------------------|-----|------|
|                    |                           |   |            |                                     | Typ <mark>[1]</mark> | Max |      |
| t <sub>pd</sub>    | propagation delay         | H0 to H1, H2 and V0 to V1, V2;<br>See <u>Figure 8</u> and <u>Figure 9</u> | [2]        | -                                   | 3                    | -   | ns   |
| t <sub>en</sub>    | enable time               | SEL to all other outputs;<br>See <u>Figure 10</u> and <u>Figure 11</u>    |            | -                                   | 15                   | -   | ns   |
| t <sub>dis</sub>   | disable time              | SEL to all other outputs;<br>See <u>Figure 10</u> and <u>Figure 11</u>    |            | -                                   | 5                    | -   | ns   |
| t <sub>b-m</sub>   | break-before-make<br>time | See Figure 12   |            | -                                   | 10                   | -   | ns   |
| t <sub>sk(o)</sub> | output skew time          | Skew between any Rn, Gn and Bn ports; see Figure 8                        | <u>[3]</u> | -                                   | 50                   | -   | ps   |

[1] All typical values are measured at V\_{CC(B)} = 5 V; V\_{CC(A)} = 3.3 V; T\_{amb} = 25 \ ^{\circ}C.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[3] Guaranteed by design.

### 11.1 Test circuits and waveforms



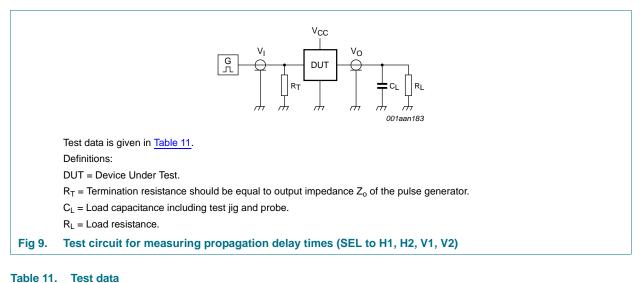
#### Table 10. Measurement points

| Input                 |                    | Output             |                       |  |
|-----------------------|--------------------|--------------------|-----------------------|--|
| V <sub>M</sub>        | VI                 | V <sub>X</sub>     | V <sub>M</sub>        |  |
| 0.5V <sub>CC(A)</sub> | GND to $V_{CC(A)}$ | 0.9V <sub>OH</sub> | 0.5V <sub>CC(B)</sub> |  |

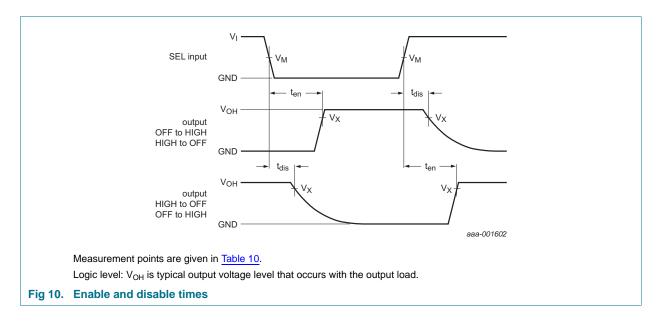
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### Dual supply 1-of-2 VGA switch

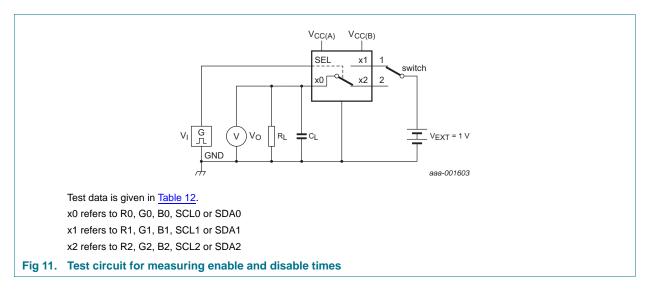


| Input                           | Load  |      |
|---------------------------------|-------|------|
| t <sub>r</sub> , t <sub>f</sub> | CL    | RL   |
| ≤ 2.5 ns                        | 10 pF | 1 kΩ |



# NX5DV713

### Dual supply 1-of-2 VGA switch

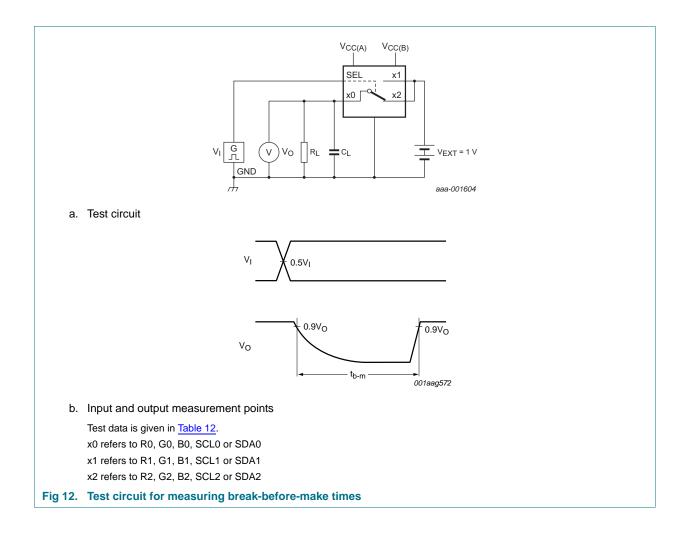


#### Table 12. Test data

| Input                           |                           | Load  |       |  |
|---------------------------------|---------------------------|-------|-------|--|
| t <sub>r</sub> , t <sub>f</sub> | VI                        | CL    | RL    |  |
| ≤ 2.5 ns                        | GND to V <sub>CC(A)</sub> | 10 pF | 100 Ω |  |

# NX5DV713

### Dual supply 1-of-2 VGA switch



# **12.** Additional dynamic characteristics

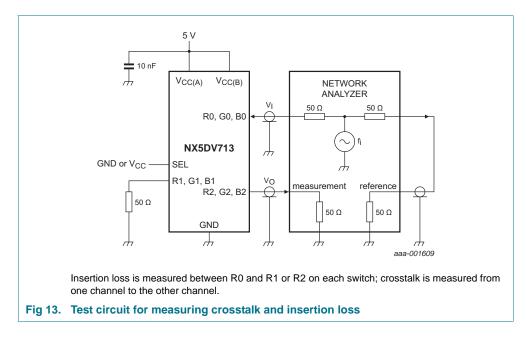
#### Table 13. Additional dynamic characteristics

 $V_{CC(B)} = 5.0 \text{ V} \pm 10 \%$ ,  $V_{CC(A)} = 2 \text{ V}$  to 5.5 V, unless otherwise specified; Voltages are referenced to GND (ground = 0 V)

| Symbol                | Parameter                | Conditions   |            | T <sub>amb</sub> = -40 °C to +85 °C |     |     | Unit |
|-----------------------|--------------------------|--|------------|-------------------------------------|-----|-----|------|
|                       |                          |  |            | Min                                 | Тур | Max |      |
| f <sub>(-3dB)</sub>   | -3 dB frequency response | $R_L = 50 \Omega$ ; see Figure 13  | <u>[1]</u> | -                                   | 600 | -   | MHz  |
| $\alpha_{\text{ins}}$ | Insertion loss           | $f_i = 1 \text{ MHz};$<br>R <sub>L</sub> = R <sub>S</sub> =50 Ω; see <u>Figure 13</u>  |            | -                                   | 0.6 | -   | dB   |
| Xtalk                 | crosstalk                | between switches; $f_i = 50 \text{ MHz}$ ;<br>$R_L = 50 \Omega$ ; see <u>Figure 13</u> | <u>[1]</u> | -                                   | -50 | -   | dB   |

[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

### 12.1 Test circuits

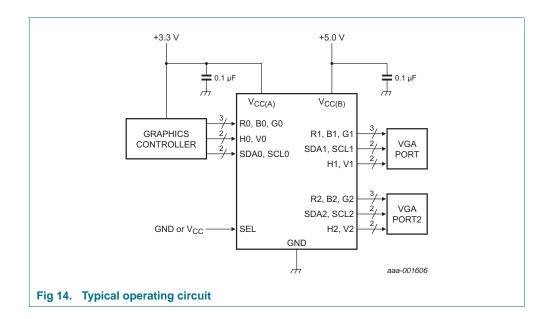


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Dual supply 1-of-2 VGA switch

# **13. Application information**

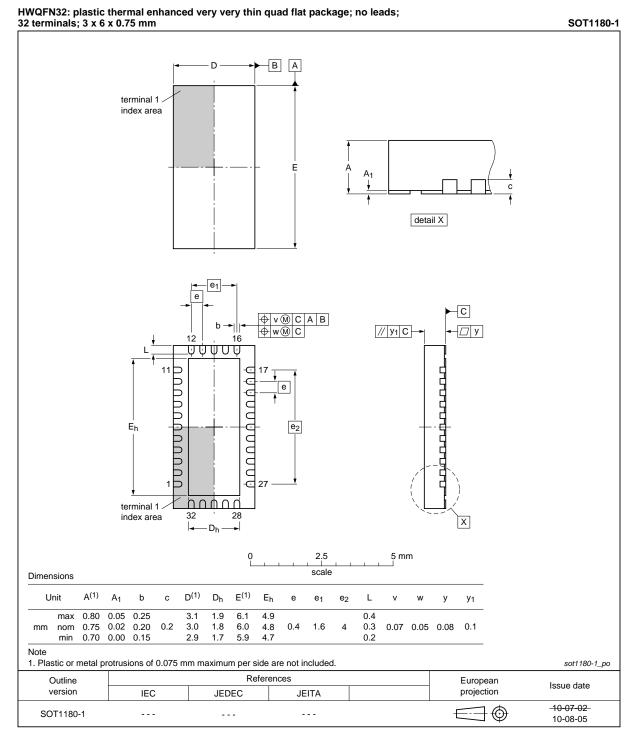
The NX5DV713 provides the level shifting necessary to drive two standard VGA ports from a graphic controller as low as 2.2 V. Internal buffers drive the HSYNC and VSYNC signals to VGA standard TTL levels. The DDC multiplexer provides level shifting by clamping signals to a diode drop less than  $V_{CC(A)}$  (See Figure 14). Connect  $V_{CC(A)}$  to 3.3 V for normal operation, or to  $V_{CC(B)}$  to disable voltage clamping for DDC signals



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# 14. Package outline



### Fig 15. Package outline SOT1180-1 (HWQFN32)

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|--------------------|--|---------------------------------------|
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# **15. Abbreviations**

| Table 14. | Abbreviations                           |
|-----------|---|
| Acronym   | Description                             |
| CDM       | Charged Device Model                    |
| DDC       | Display Data Channel                    |
| ESD       | ElectroStatic Discharge                 |
| HBM       | Human Body Model                        |
| MM        | Machine Model                           |
| RGB       | Red Green Blue                          |
| SPDT      | Single-Pole Double-Throw                |
| TTL       | Transistor-Transistor Logic             |
| VESA      | Video Electronics Standards Association |

# 16. Revision history

### Table 15. Revision history

| Document ID  | Release date | Data sheet status  | Change notice | Supersedes |
|--------------|--------------|--------------------|---------------|------------|
| NX5DV713 v.1 | 20111124     | Product data sheet | -             | -          |

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| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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